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STMicroelectronics STP12N50M2

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# N-channel 500 V, 0.325 Ω typ.,10 A MDmesh II Plus™ low Q<sub>g</sub> Power MOSFET in a TO-220 package

Datasheet - preliminary data

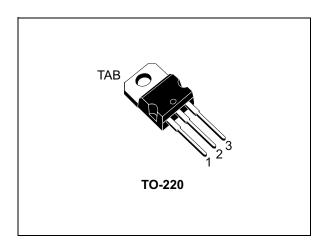
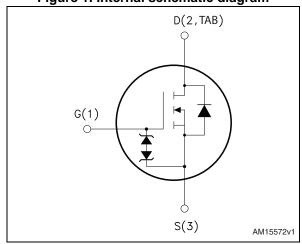


Figure 1. Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STP12N50M2	500 V	0.38 Ω	10 A

- Extremely low gate charge
- Lower R<sub>DS(on)</sub> x area vs previous generation
- · Low gate input resistance
- 100% avalanche tested
- Zener-protected

## **Applications**

· Switching applications

## **Description**

This device is an N-channel Power MOSFET developed using a new generation of MDmesh  $^{\mathsf{TM}}$  technology: MDmesh II Plus  $^{\mathsf{TM}}$  low  $Q_g$ . This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

**Table 1. Device summary** 

Order code	Marking	Package	Packaging
STP12N50M2	12N50M2	TO-220	Tube

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STP12N50M2 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	± 25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	10	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	7	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	40	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	85	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	- 55 to 150	

- 1. Pulse width limited by safe operating area.
- 2.  $I_{SD} \leq$  10 A, di/dt  $\leq$  400 A/ $\mu$ s;  $V_{DS peak}$  <  $V_{(BR)DSS}$ ,  $V_{DD}$ =400 V.
- 3.  $V_{DS} \le 400 V$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.47	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb max	62.5	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	3.5	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>j</sub> =25°C, I <sub>D</sub> = I <sub>AR</sub> ; V <sub>DD</sub> =50)	204	mJ

Electrical characteristics

STP12N50M2

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	500			V
	Zero gate voltage	$V_{GS} = 0, V_{DS} = 500 \text{ V}$			1	μΑ
I <sub>DSS</sub>	drain current	$V_{GS} = 0$ , $V_{DS} = 500 V$ , $T_C = 125 °C$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		0.325	0.38	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	560	-	pF
C <sub>oss</sub>	Output capacitance	$V_{GS} = 0, V_{DS} = 100 V,$	-	33	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	f = 1 MHz	-	1	-	pF
C <sub>oss eq.</sub> <sup>(1)</sup>	Equivalent output capacitance	V <sub>GS</sub> = 0, V <sub>DS</sub> = 0 to 400 V	-	125	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	6.8	-	Ω
Qg	Total gate charge	V 400 V I 40 A	-	15	-	nC
Q <sub>gs</sub>	Gate-source charge	$V_{DD} = 400 \text{ V}, I_{D} = 10 \text{ A},$ $V_{GS} = 10 \text{ V} \text{ (see Figure 15)}$	-	3	-	nC
Q <sub>gd</sub>	Gate-drain charge	- 165 - 16 1 (655) rigulo 10)	-	8.3	-	nC

<sup>1.</sup>  $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 



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### **Electrical characteristics**

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	13.5	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = 250 \text{ V}, I_D = 5 \text{ A},$	-	10.5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see <i>Figure 14</i> and <i>19</i> )	-	8	-	ns
t <sub>f</sub>	Fall time		-	34.5	-	ns

### Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current	Source-drain current			10	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		40	Α
V <sub>SD</sub> (2)	Forward on voltage	V <sub>GS</sub> = 0, I <sub>SD</sub> = 10 A	-		1.6	٧
t <sub>rr</sub>	Reverse recovery time	10.4 11/11 100.4/	-	276		ns
Q <sub>rr</sub>	Reverse recovery charge	$I_{SD} = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V (see Figure 16)}$	-	2.4		μC
I <sub>RRM</sub>	Reverse recovery current	TDD co i (coo i igalo io)	-	17.5		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 10 A, di/dt = 100 A/ <i>μ</i> s	-	376		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V, T <sub>j</sub> =150 °C	-	3.4		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16)	-	18.3		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STP12N50M2

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

10 GIPG040620140931SA

(A) 10μs

Figure 3. Thermal impedance

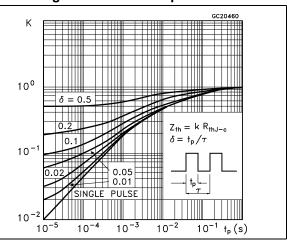
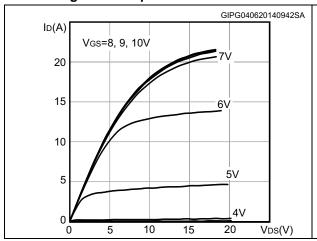


Figure 4. Output characteristics

Figure 5. Transfer characteristics



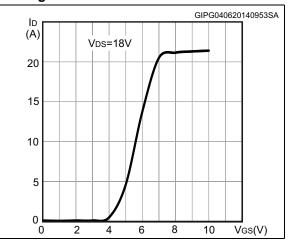
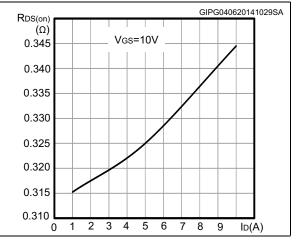


Figure 6. Gate charge vs gate-source voltage

(V) Vds V<sub>DD</sub>=400V 400 12 ID=10A 350 10 300 8 250 200 6 150 4 100 2 50 0 10 15 5 Qg(nC)

Figure 7. Static drain-source on-resistance



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**Electrical characteristics** 

Figure 8. Capacitance variations

C (pF) 1000 Ciss Coss 10 1 10 100 VDs(V)

Figure 9. Output capacitance stored energy

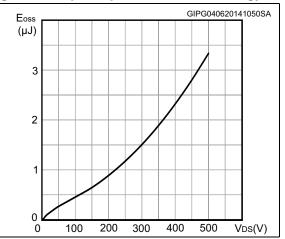


Figure 10. Normalized gate threshold voltage vs temperature

temperature

VGS(th) GIPG040620141054SA

1.1

1.0

0.9

0.8

0.7

-50 -25 0 25 50 75 100 TJ(°C)

Figure 11. Normalized on-resistance vs temperature

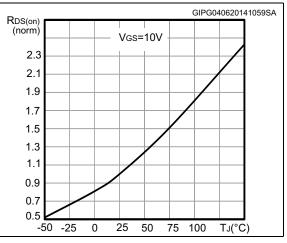
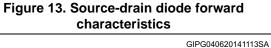
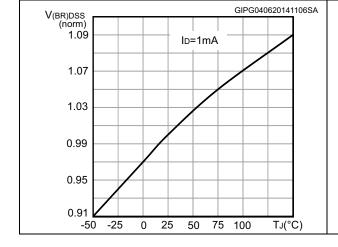
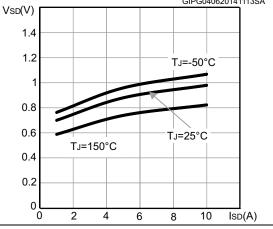


Figure 12. Normalized V<sub>(BR)DSS</sub> vs temperature











Test circuits STP12N50M2

# 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

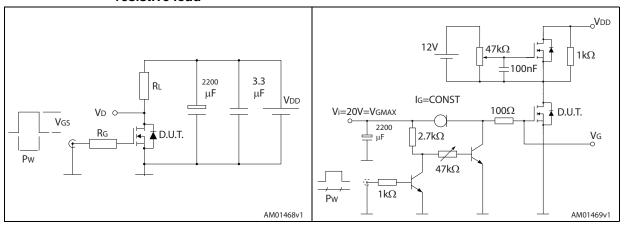


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

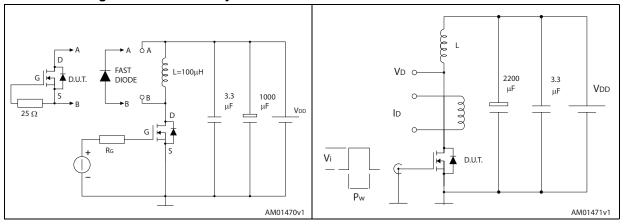
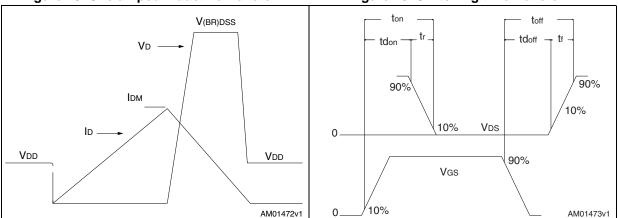


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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Datasheet of STP12N50M2 - MOSFET N-CH 500V 10A TO-220AB

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### STP12N50M2

Package mechanical data

# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



### Package mechanical data

STP12N50M2

Figure 20. TO-220 type A drawing øΡ H1 D1 L20 L30 b1(X3) b (X3) 0015988\_typeA\_Rev\_T





### Package mechanical data

Table 9. TO-220 type A mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95



Revision history STP12N50M2

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
17-Jun-2014	1	First release.





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Datasheet of STP12N50M2 - MOSFET N-CH 500V 10A TO-220AB

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